

600V 77A Super Junction MOSFET

Features :

- New revolutionary high voltage technology
- Ultra Low gate charge
- Periodic avalancherated
- Extreme dv/dt rated
- $R_{DS(ON)} < 41m\Omega @ V_{GS}=10V$
- RoHS compliant

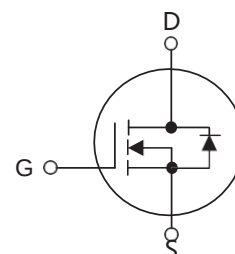
TO-247



Block Diagram

Pin Definition:

1. Gate
2. Drain
3. Source



Mechanical Data :

- TO-247 package

Ordering Information

Part No.	Package Type	Package	Quality(box)
KWSJ77N60P	TO-247	Tube	600

PRODUCT SUMMARY

$V_{DS}(V)$	$R_{DS(on)}(m\Omega)_{Typ}$	$I_D(A)$
600	35@ $V_{GS}=10V$	77

Table1 Absolute Maximum Ratings ($T_C=25^\circ C$, unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current	I_D	$T_C=25^\circ C$	A
		$T_C=100^\circ C$	
Pulsed Drain Current (Note 1)	I_{DM}	260	A
Single Pulse Avalanche Energy(Note 2)	E_{AS}	1950	mJ
Avalanche Current(Note 1)	I_{AR}	13	A
Repetitive Avalanche Energy(Note 1)	E_{AR}	2.5	mJ
Peak Diode Recovery dv/dt(Note 3)	dv/dt	15	V/ns
Drain Source voltage slope($V_{DS}=480V$)	d V_{DS} /dt	50	V/ns
Power Dissipation $T_C=25^\circ C$	P_D	400	W
Operating Junction and Storage Temperature	T_J/T_{STG}	-55 ~ +150	$^\circ C$
Maximum Temperature for soldering	T_L	300	$^\circ C$

Table 2. Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance Junction to Ambient	$R_{\theta JA}$	62	$^{\circ}\text{C/W}$
Thermal resistance Junction to Case	$R_{\theta JC}$	0.32	$^{\circ}\text{C/W}$

Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Off Characteristics							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V,I _D =250μA	600	--	--	V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V,V _{GS} =0V	--	--	1	μA
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =30V,V _{DS} =0V	--	--	100	nA
	Reverse		V _{GS} =-30V,V _{DS} =0V	--	--	-100	nA
On Characteristics(Note 4)							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} ,I _D =250μA	2.5	--	4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V,I _D =35A	--	35	41	mΩ
Dynamic Characteristics(Note 5)							
Input Capacitance		C _{ISS}	V _{DS} =25V,V _{GS} =0V,f=1MHz	--	6200	--	pF
Output Capacitance		C _{OSS}		--	300	--	pF
Reverse Transfer Capacitance		C _{RSS}		--	12	--	pF
Switching Characteristics (Note 5)							
Turn-On Delay Time		t _{d (on)}	V _{DD} =480V,I _D =35A, R _G =20Ω	--	39	--	ns
Turn-On Rise Time		t _R		--	20	--	ns
Turn-Off Delay Time		t _{d (off)}		--	100	--	ns
Turn-Off Fall Time		t _f		--	5	--	ns
Total Gate Charge		Q _G	V _{DS} =480V,I _D =35A, V _{GS} =10V	--	300	--	nC
Gate-Source Charge		Q _{GS}		--	59	--	nC
Gate-Drain Charge		Q _{GD}		--	195	--	nC
Drain-Source Diode Characteristics and Maximum Ratings							
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} =0V, I _S =35A	--	0.9	1.5	V
Maximum Continuous Drain-Source Diode Forward Current		I _S		--	--	77	A
Reverse Recovery Time		trr	V _{GS} =0V, I _S =23A	--	900	--	ns
Reverse Recovery Charge		Q _{RR}	dI _F /dt=100A/μs (Note 1)	--	19	--	μC

Notes : 1 Repetitive Rating:Pulse width limited by maximum junction temperature 2

Pulse width t_p limited by $T_{j,max}$

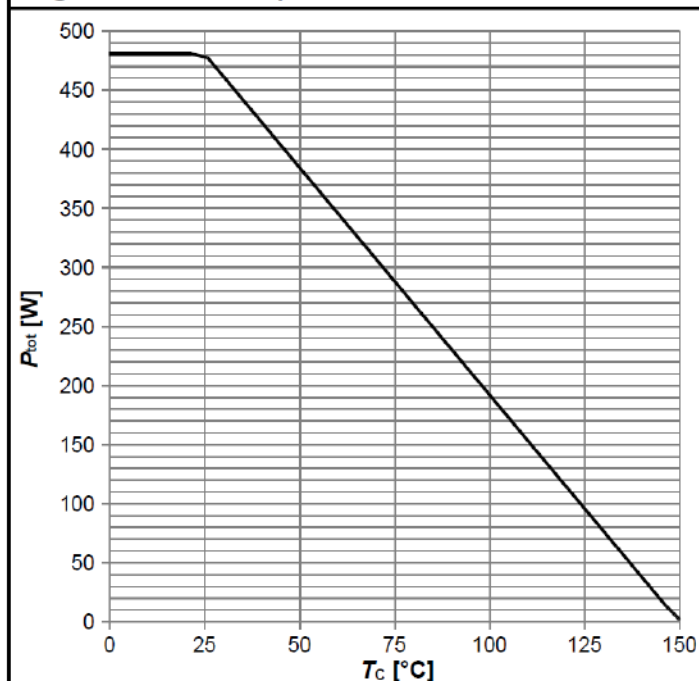
3 Identical low side and high side switch with identical R_G ; $V_{peak}<V(BR)_{DSS}$; $T_j<T_{j,max}$

4 Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

5 Guaranteed by design, not subject to production

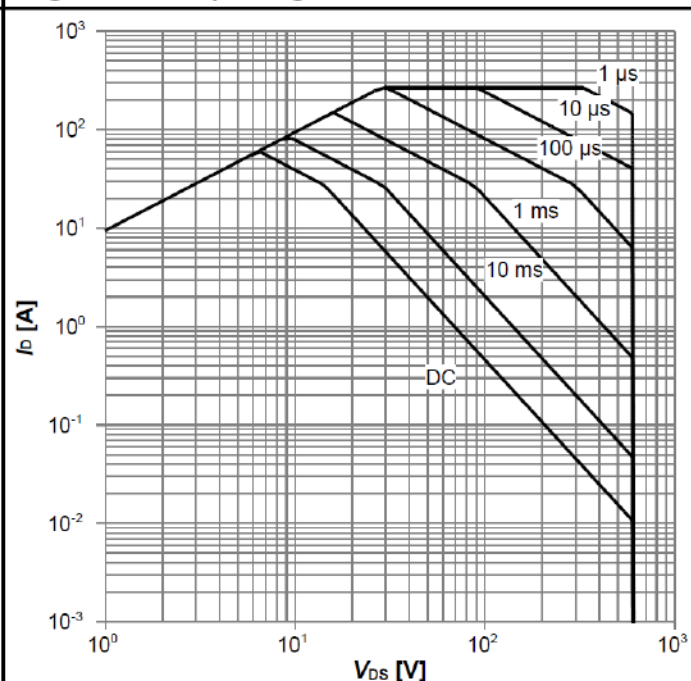
Typical characteristics Diagrams

Diagram 1: Power dissipation



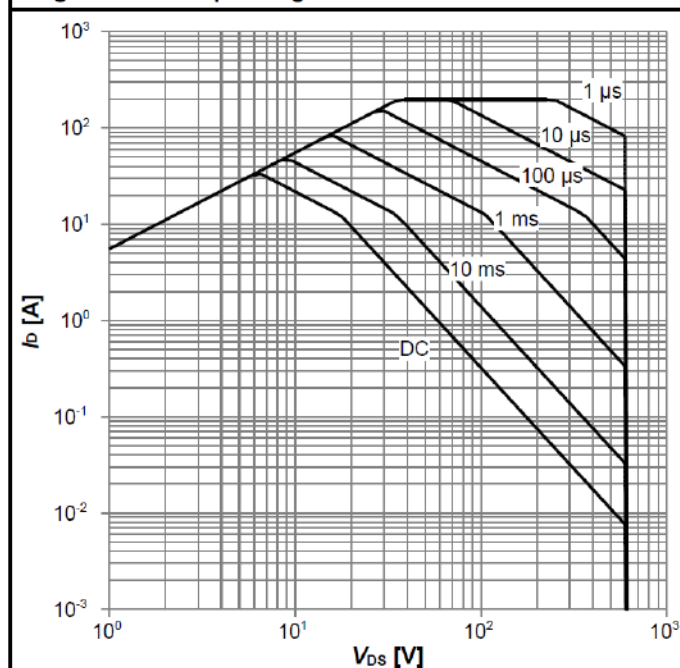
$$P_{tot}=f(T_c)$$

Diagram 2: Safe operating area



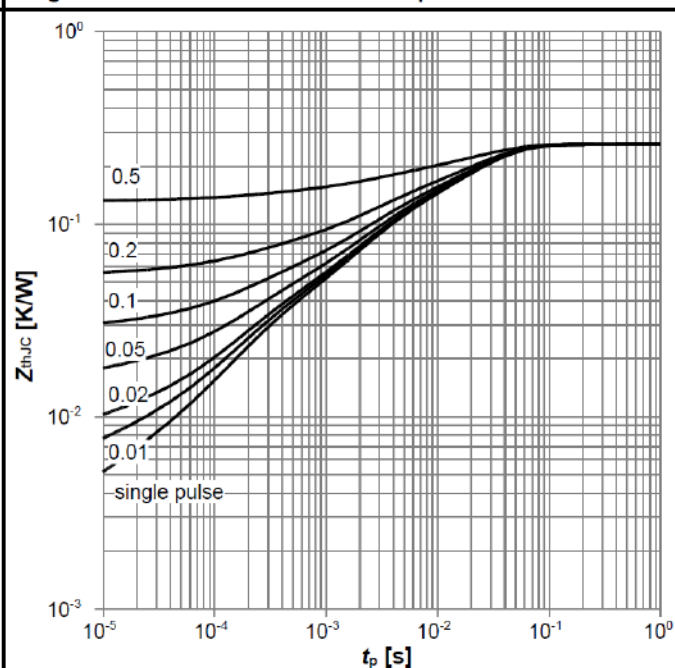
$$I_D=f(V_{DS}); T_c=25\text{ }^{\circ}\text{C}; D=0; \text{parameter: } t_p$$

Diagram 3: Safe operating area



$$I_D=f(V_{DS}); T_c=80\text{ }^{\circ}\text{C}; D=0; \text{parameter: } t_p$$

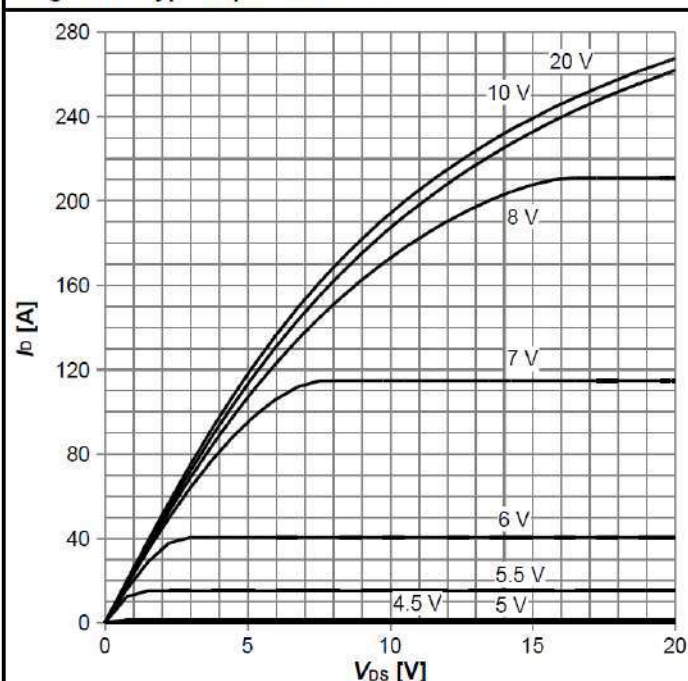
Diagram 4: Max. transient thermal impedance



$$Z_{thJC}=f(t_p); \text{parameter: } D=t_p/T$$

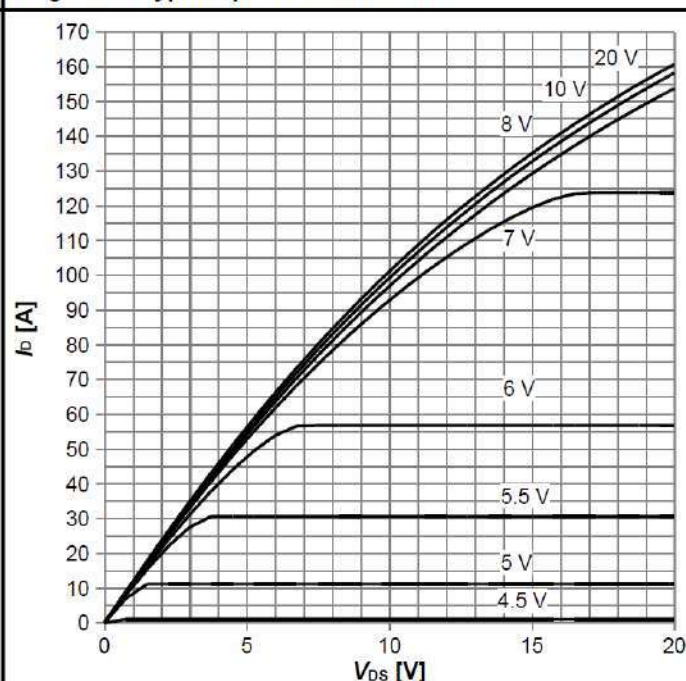
Typical characteristics Diagrams

Diagram 5: Typ. output characteristics



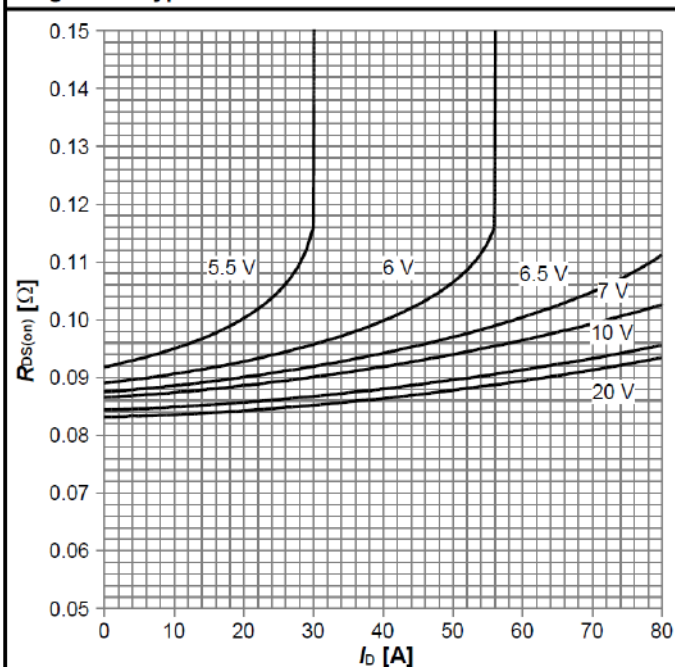
$I_D = f(V_{DS}); T_J = 25^\circ\text{C}; \text{parameter: } V_{GS}$

Diagram 6: Typ. output characteristics



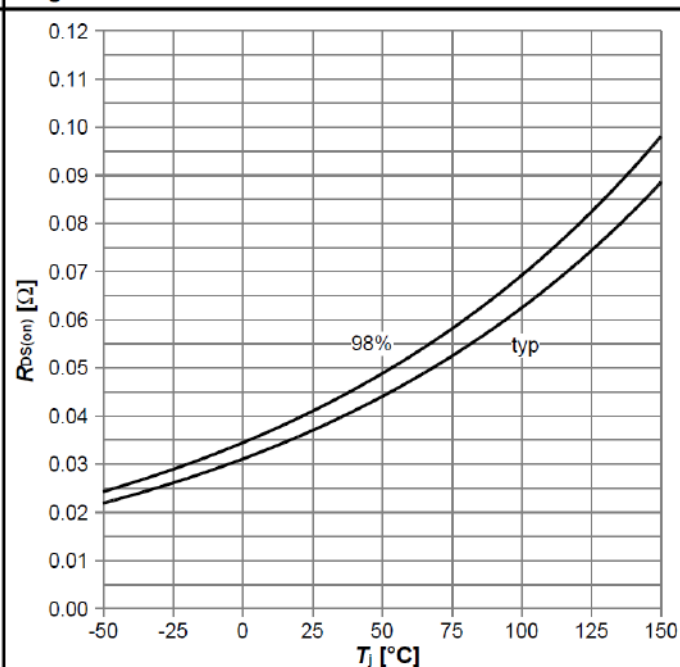
$I_D = f(V_{DS}); T_J = 125^\circ\text{C}; \text{parameter: } V_{GS}$

Diagram 7: Typ. drain-source on-state resistance



$R_{DS(on)} = f(I_D); T_J = 125^\circ\text{C}; \text{parameter: } V_{GS}$

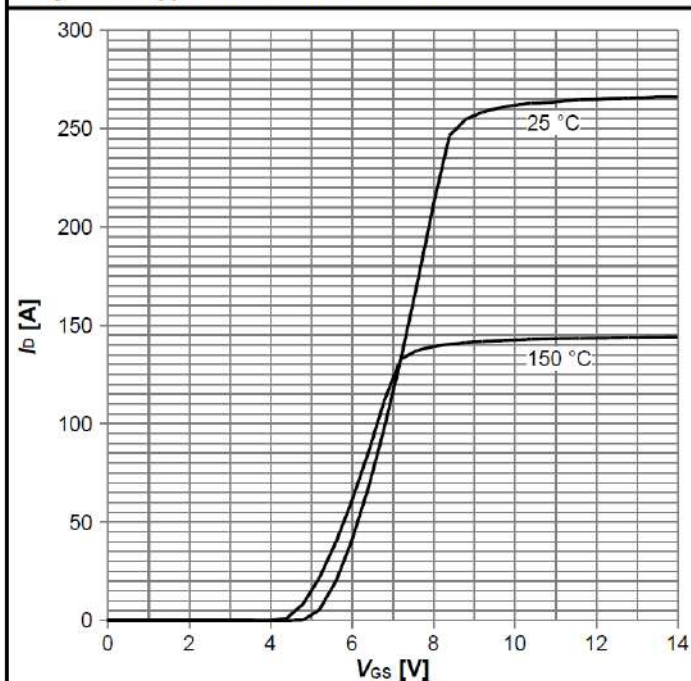
Diagram 8: Drain-source on-state resistance



$R_{DS(on)} = f(T_J); I_D = 35.5\text{ A}; V_{GS} = 10\text{ V}$

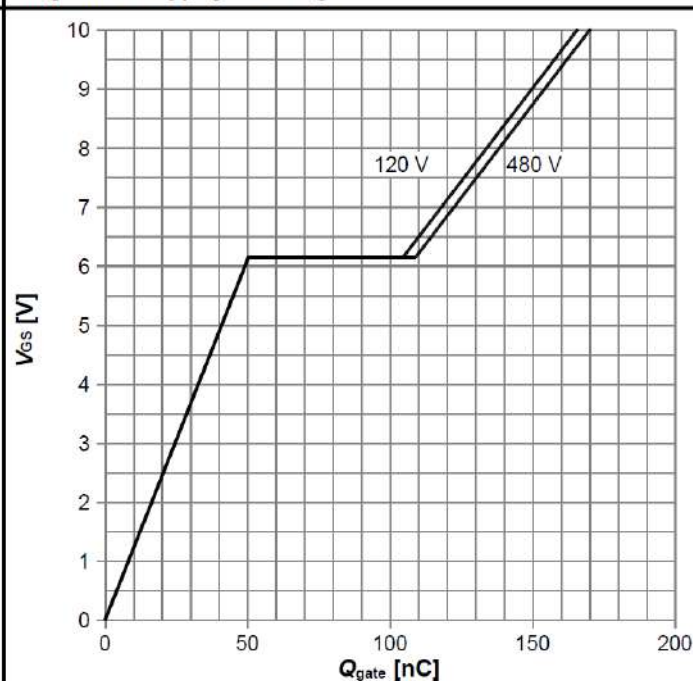
Typical characteristics Diagrams

Diagram 9: Typ. transfer characteristics



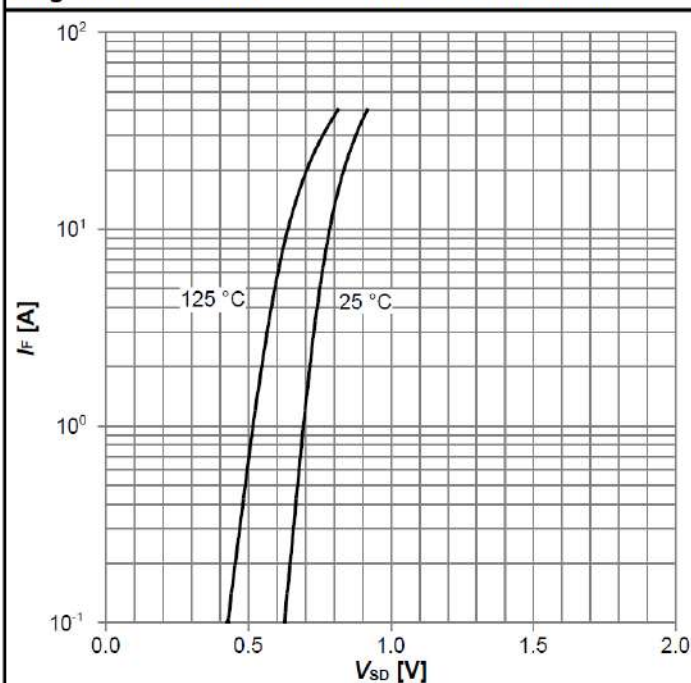
$I_D = f(V_{GS})$; $V_{DS} = 20V$; parameter: T_j

Diagram 10: Typ. gate charge



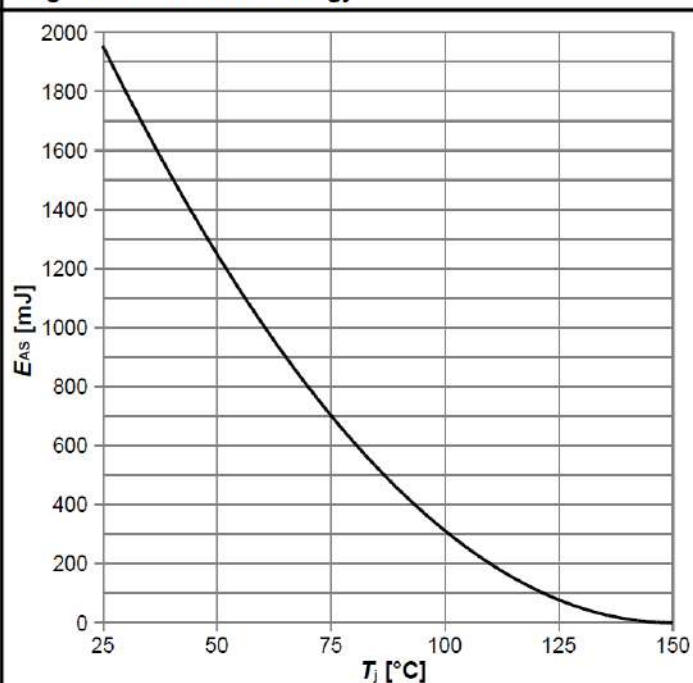
$V_{GS} = f(Q_{gate})$; $I_D = 44.4 A$ pulsed; parameter: V_{DD}

Diagram 11: Forward characteristics of reverse diode



$I_F = f(V_{SD})$; parameter: T_j

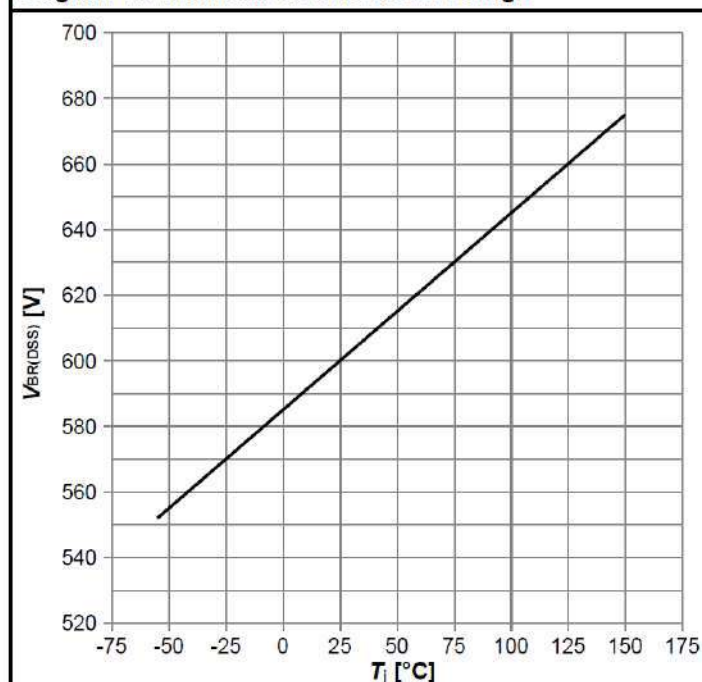
Diagram 12: Avalanche energy



$E_{AS} = f(T_j)$; $I_D = 13.4 A$; $V_{DD} = 50 V$

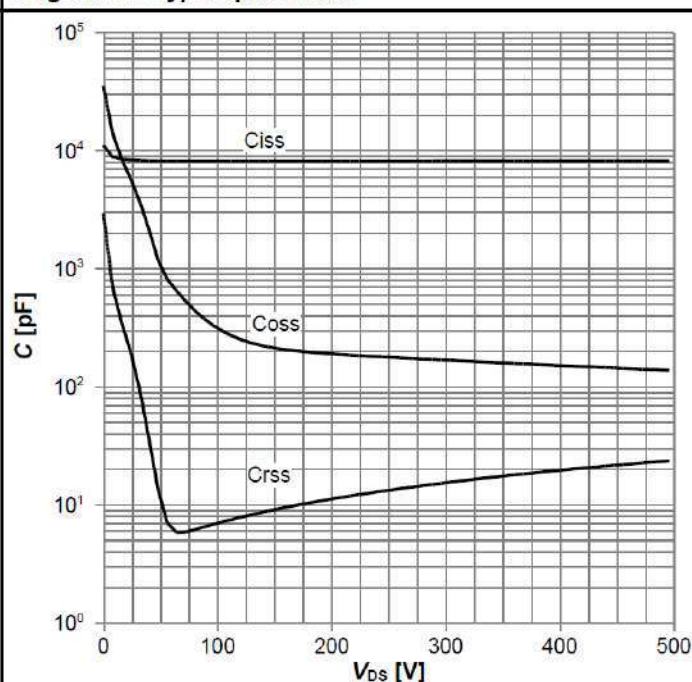
Typical characteristics Diagrams

Diagram 13: Drain-source breakdown voltage



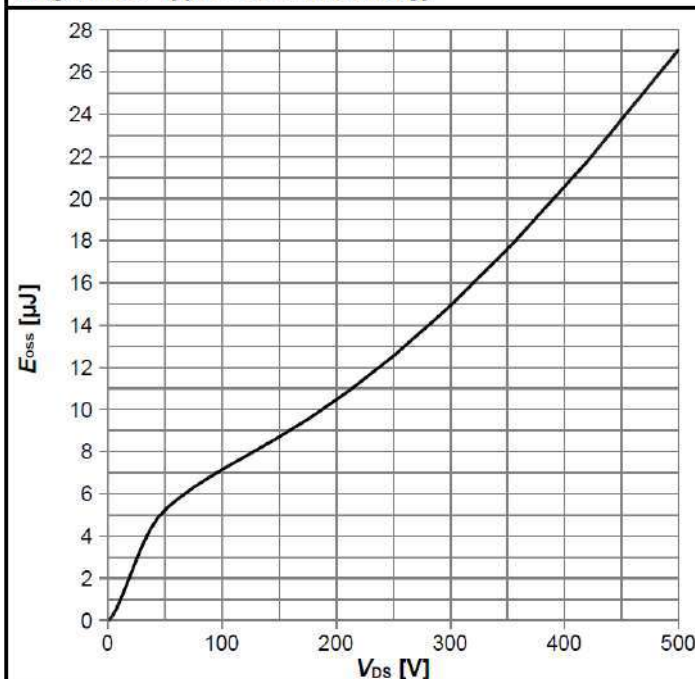
$$V_{BR(DSS)} = f(T_J); I_D = 1 \text{ mA}$$

Diagram 14: Typ. capacitances



$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$

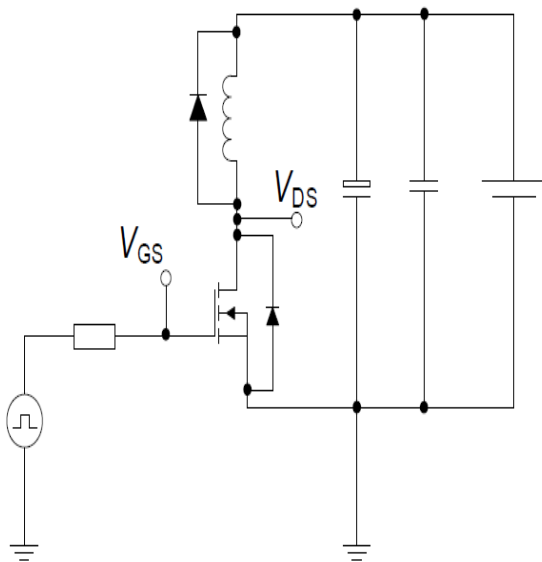
Diagram 15: Typ. Coss stored energy



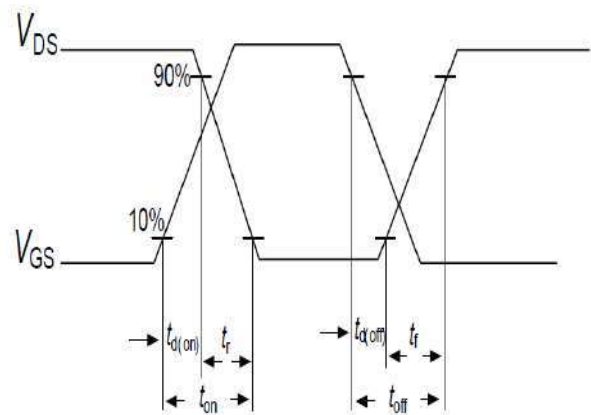
$$E_{oss} = f(V_{DS})$$

Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

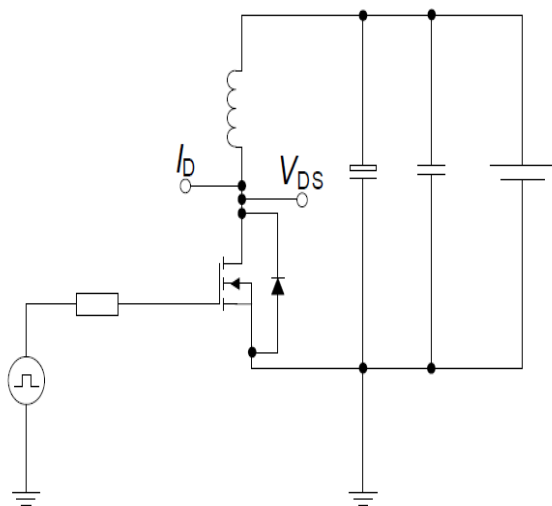


Switching time waveform

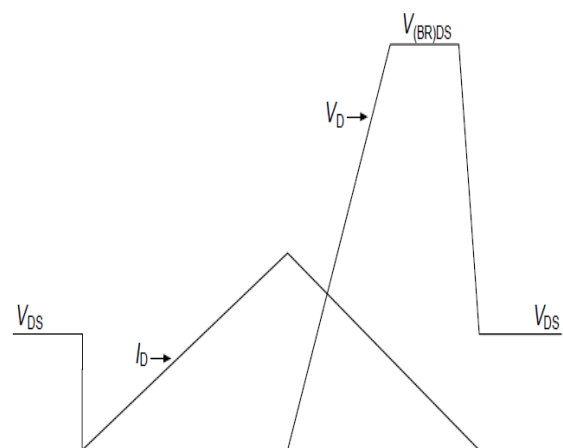


Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit

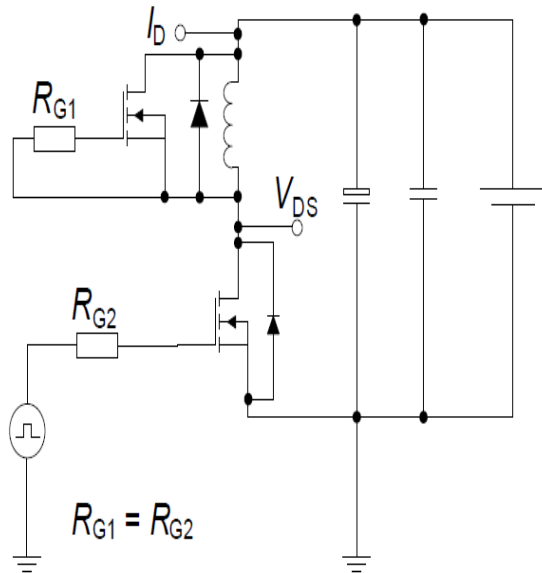


Unclamped inductive waveform

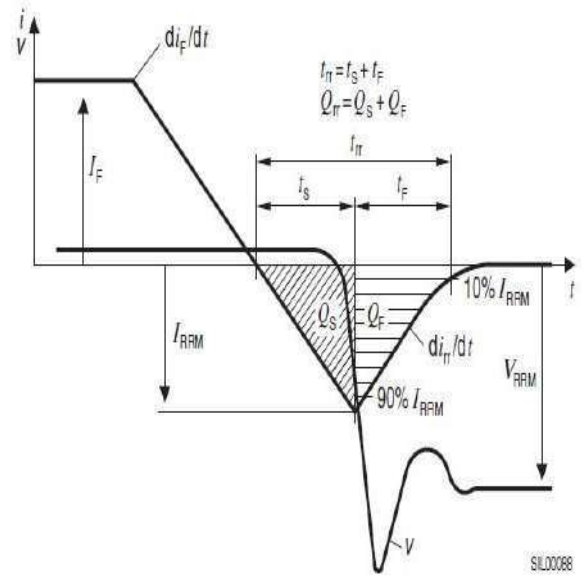


Test circuit and waveform for diode characteristics

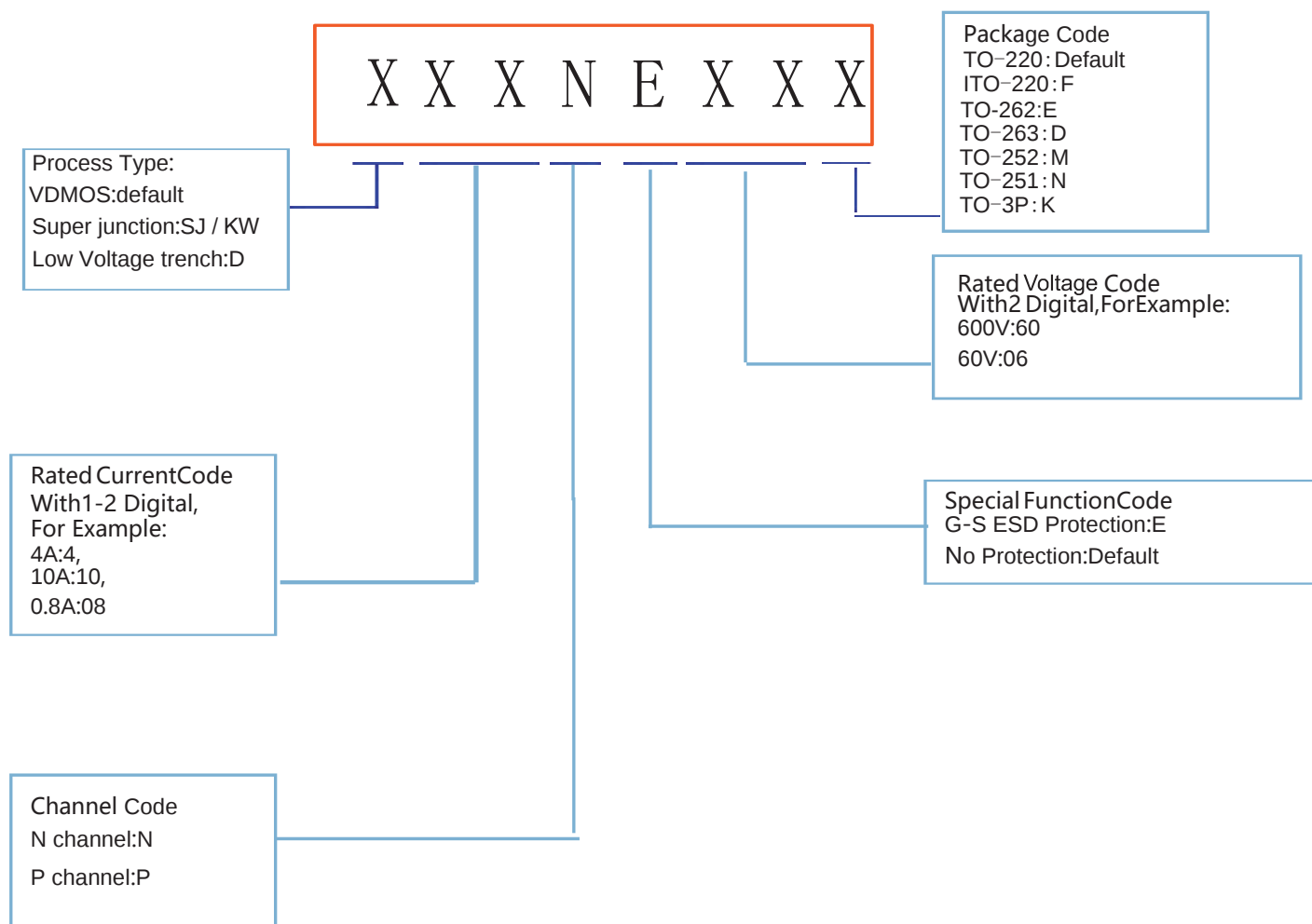
Test circuit for diode characteristics



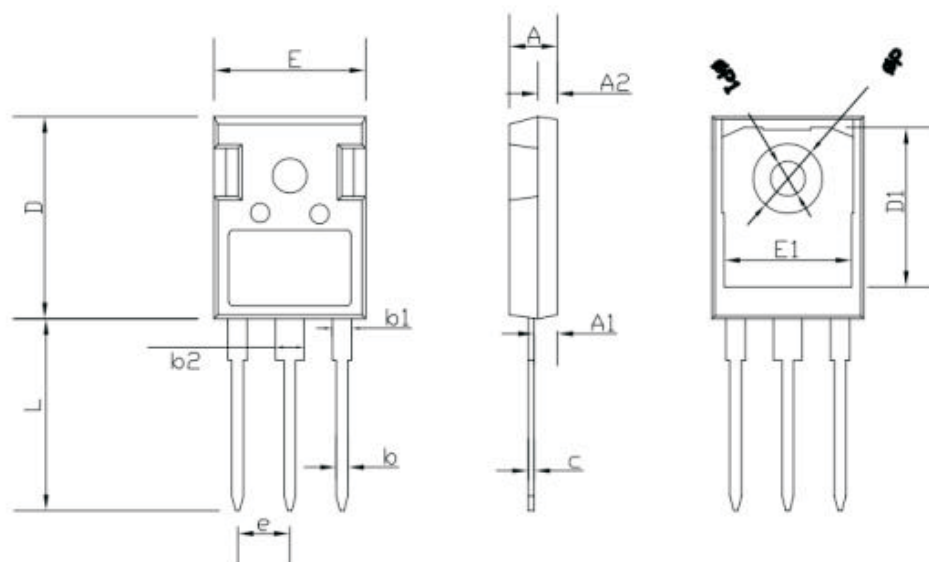
Diode recovery waveform



Product Names Rules



TO-247 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
A	4.90	5.10	0.193	0.201
A1	2.31	2.51	0.091	0.099
A2	1.90	2.10	0.075	0.083
b	1.16	1.26	0.046	0.050
b1	1.96	2.06	0.0772	0.0812
b2	2.96	3.06	0.117	0.121
c	0.59	0.66	0.0232	0.0260
D	20.90	21.10	0.8235	0.8313
D1	16.25	16.85	0.6403	0.6639
E	15.70	15.90	0.6186	0.6265
E1	13.10	13.50	0.5161	0.5319
e	5.44		0.2143	
L	19.80	20.10	0.7801	0.7919
ΦP	3.50	3.70	0.1379	0.1458
ΦP1	0	7.30	0	0.2876